2SB0954, 2SB0954A (2SB954, 2SB954A)

Silicon PNP epitaxial planar type

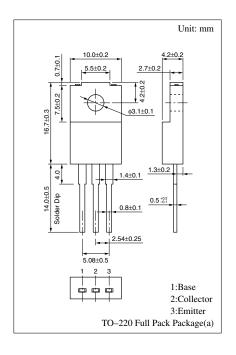
For power amplification

Features

- High forward current transfer ratio h_{FE} which has satisfactory linearity
- Low collector to emitter saturation voltage V_{CE(sat)}
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings (T_C=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SB0954	3.7	-60	V	
base voltage	2SB0954A	V_{CBO}	-80		
Collector to	2SB0954	37	-60	3.7	
emitter voltage	2SB0954A	V_{CEO}	-80	V	
Emitter to base voltage		V_{EBO}	-5	V	
Peak collector current		I _{CP}	-2	A	
Collector current		I_{C}	-1	A	
Collector power	T _C =25°C	D	30	W	
dissipation	Ta=25°C	P_{C}	2		
Junction temperature		T _j	150	°C	
Storage temperature		T_{stg}	-55 to +150	°C	



Electrical Characteristics (T_C=25°C)

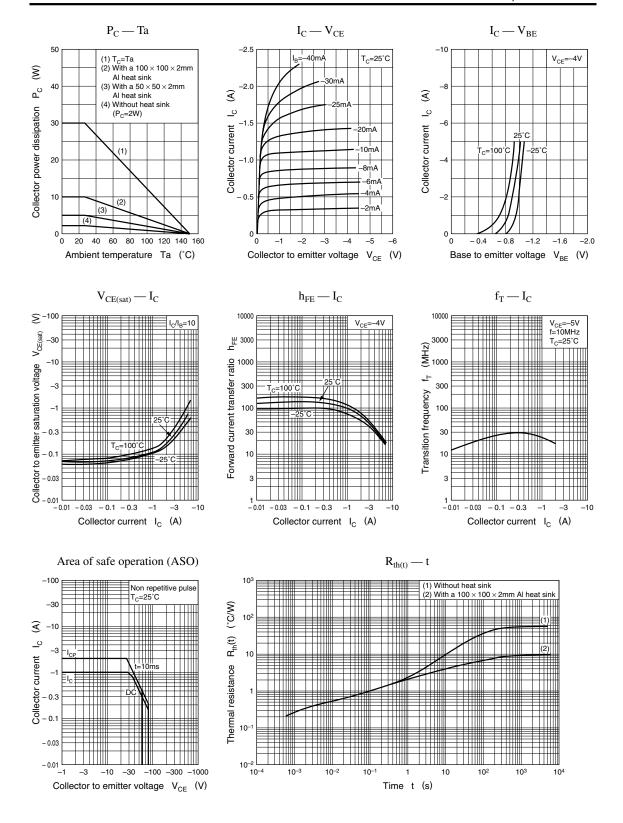
Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff	2SB0954	т	$V_{CE} = -30V, I_B = 0$			-300	
current	2SB0954A	I _{CEO}	$V_{CE} = -60V, I_{B} = 0$			-300	μA
Collector cutoff	2SB0954	I _{CES}	$V_{CE} = -60V, V_{BE} = 0$			-200	μА
current	2SB0954A		$V_{CE} = -80V, V_{BE} = 0$			-200	
Emitter cutoff current		I _{EBO}	$V_{EB} = -5V, I_{C} = 0$			-1	mA
Collector to emitter	2SB0954	V _{CEO}	$I_{\rm C} = -30 {\rm mA}, I_{\rm B} = 0$	-60			V
voltage	2SB0954A			-80			
Forward current transfer ratio		h _{FE1} *	$V_{CE} = -4V, I_{C} = -0.2A$	70		250	
		h _{FE2}	$V_{CE} = -4V, I_{C} = -1A$	15			
Collector to emitter saturation voltage		V _{CE(sat)}	$I_C = -1A, I_B = -0.125A$			-1	V
Base to emitter voltage		V _{BE}	$V_{CE} = -4V, I_{C} = -1A$			-1.3	V
Transition frequency		f_{T}	$V_{CE} = -5V, I_C = -0.2A, f = 10MHz$		30		MHz
Turn-on time		t _{on}	$I_C = -1A$, $I_{B1} = -0.1A$, $I_{B2} = 0.1A$,		0.5		μs
Storage time		t _{stg}			1.2		μs
Fall time		t _f	$V_{CC} = -50V$		0.3		μs

*h_{FE1} Rank classification

Rank	Q	P
h_{FE1}	70 to 150	120 to 250

Note.) The Part numbers in the Parenthesis show conventional part number.

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